

Power Systems

*SAS subsystem for the 8202-E4B or
8205-E6B*

IBM

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*SAS subsystem for the 8202-E4B or
8205-E6B*

IBM

Note

Before using this information and the product it supports, read the information in “Safety notices” on page v, “Notices” on page 17, the *IBM Systems Safety Notices* manual, G229-9054, and the *IBM Environmental Notices and User Guide*, Z125-5823.

This edition applies to IBM Power Systems servers that contain the POWER7 processor and to all associated models.

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Safety notices

Safety notices may be printed throughout this guide:

- **DANGER** notices call attention to a situation that is potentially lethal or extremely hazardous to people.
- **CAUTION** notices call attention to a situation that is potentially hazardous to people because of some existing condition.
- **Attention** notices call attention to the possibility of damage to a program, device, system, or data.

World Trade safety information

Several countries require the safety information contained in product publications to be presented in their national languages. If this requirement applies to your country, safety information documentation is included in the publications package (such as in printed documentation, on DVD, or as part of the product) shipped with the product. The documentation contains the safety information in your national language with references to the U.S. English source. Before using a U.S. English publication to install, operate, or service this product, you must first become familiar with the related safety information documentation. You should also refer to the safety information documentation any time you do not clearly understand any safety information in the U.S. English publications.

Replacement or additional copies of safety information documentation can be obtained by calling the IBM Hotline at 1-800-300-8751.

German safety information

Das Produkt ist nicht für den Einsatz an Bildschirmarbeitsplätzen im Sinne § 2 der Bildschirmarbeitsverordnung geeignet.

Laser safety information

IBM® servers can use I/O cards or features that are fiber-optic based and that utilize lasers or LEDs.

Laser compliance

IBM servers may be installed inside or outside of an IT equipment rack.

DANGER

When working on or around the system, observe the following precautions:

Electrical voltage and current from power, telephone, and communication cables are hazardous. To avoid a shock hazard:

- Connect power to this unit only with the IBM provided power cord. Do not use the IBM provided power cord for any other product.
- Do not open or service any power supply assembly.
- Do not connect or disconnect any cables or perform installation, maintenance, or reconfiguration of this product during an electrical storm.
- The product might be equipped with multiple power cords. To remove all hazardous voltages, disconnect all power cords.
- Connect all power cords to a properly wired and grounded electrical outlet. Ensure that the outlet supplies proper voltage and phase rotation according to the system rating plate.
- Connect any equipment that will be attached to this product to properly wired outlets.
- When possible, use one hand only to connect or disconnect signal cables.
- Never turn on any equipment when there is evidence of fire, water, or structural damage.
- Disconnect the attached power cords, telecommunications systems, networks, and modems before you open the device covers, unless instructed otherwise in the installation and configuration procedures.
- Connect and disconnect cables as described in the following procedures when installing, moving, or opening covers on this product or attached devices.

To Disconnect:

1. Turn off everything (unless instructed otherwise).
2. Remove the power cords from the outlets.
3. Remove the signal cables from the connectors.
4. Remove all cables from the devices.

To Connect:

1. Turn off everything (unless instructed otherwise).
2. Attach all cables to the devices.
3. Attach the signal cables to the connectors.
4. Attach the power cords to the outlets.
5. Turn on the devices.

(D005)

DANGER

Observe the following precautions when working on or around your IT rack system:

- Heavy equipment—personal injury or equipment damage might result if mishandled.
- Always lower the leveling pads on the rack cabinet.
- Always install stabilizer brackets on the rack cabinet.
- To avoid hazardous conditions due to uneven mechanical loading, always install the heaviest devices in the bottom of the rack cabinet. Always install servers and optional devices starting from the bottom of the rack cabinet.
- Rack-mounted devices are not to be used as shelves or work spaces. Do not place objects on top of rack-mounted devices.



- Each rack cabinet might have more than one power cord. Be sure to disconnect all power cords in the rack cabinet when directed to disconnect power during servicing.
- Connect all devices installed in a rack cabinet to power devices installed in the same rack cabinet. Do not plug a power cord from a device installed in one rack cabinet into a power device installed in a different rack cabinet.
- An electrical outlet that is not correctly wired could place hazardous voltage on the metal parts of the system or the devices that attach to the system. It is the responsibility of the customer to ensure that the outlet is correctly wired and grounded to prevent an electrical shock.

CAUTION

- Do not install a unit in a rack where the internal rack ambient temperatures will exceed the manufacturer's recommended ambient temperature for all your rack-mounted devices.
- Do not install a unit in a rack where the air flow is compromised. Ensure that air flow is not blocked or reduced on any side, front, or back of a unit used for air flow through the unit.
- Consideration should be given to the connection of the equipment to the supply circuit so that overloading of the circuits does not compromise the supply wiring or overcurrent protection. To provide the correct power connection to a rack, refer to the rating labels located on the equipment in the rack to determine the total power requirement of the supply circuit.
- *(For sliding drawers.)* Do not pull out or install any drawer or feature if the rack stabilizer brackets are not attached to the rack. Do not pull out more than one drawer at a time. The rack might become unstable if you pull out more than one drawer at a time.
- *(For fixed drawers.)* This drawer is a fixed drawer and must not be moved for servicing unless specified by the manufacturer. Attempting to move the drawer partially or completely out of the rack might cause the rack to become unstable or cause the drawer to fall out of the rack.

(R001)

CAUTION:

Removing components from the upper positions in the rack cabinet improves rack stability during relocation. Follow these general guidelines whenever you relocate a populated rack cabinet within a room or building:

- Reduce the weight of the rack cabinet by removing equipment starting at the top of the rack cabinet. When possible, restore the rack cabinet to the configuration of the rack cabinet as you received it. If this configuration is not known, you must observe the following precautions:
 - Remove all devices in the 32U position and above.
 - Ensure that the heaviest devices are installed in the bottom of the rack cabinet.
 - Ensure that there are no empty U-levels between devices installed in the rack cabinet below the 32U level.
- If the rack cabinet you are relocating is part of a suite of rack cabinets, detach the rack cabinet from the suite.
- Inspect the route that you plan to take to eliminate potential hazards.
- Verify that the route that you choose can support the weight of the loaded rack cabinet. Refer to the documentation that comes with your rack cabinet for the weight of a loaded rack cabinet.
- Verify that all door openings are at least 760 x 230 mm (30 x 80 in.).
- Ensure that all devices, shelves, drawers, doors, and cables are secure.
- Ensure that the four leveling pads are raised to their highest position.
- Ensure that there is no stabilizer bracket installed on the rack cabinet during movement.
- Do not use a ramp inclined at more than 10 degrees.
- When the rack cabinet is in the new location, complete the following steps:
 - Lower the four leveling pads.
 - Install stabilizer brackets on the rack cabinet.
 - If you removed any devices from the rack cabinet, repopulate the rack cabinet from the lowest position to the highest position.
- If a long-distance relocation is required, restore the rack cabinet to the configuration of the rack cabinet as you received it. Pack the rack cabinet in the original packaging material, or equivalent. Also lower the leveling pads to raise the casters off of the pallet and bolt the rack cabinet to the pallet.

(R002)

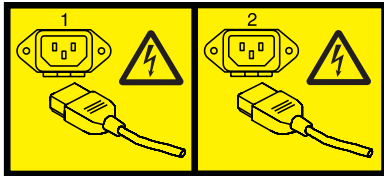
(L001)



(L002)



(L003)



or



All lasers are certified in the U.S. to conform to the requirements of DHHS 21 CFR Subchapter J for class 1 laser products. Outside the U.S., they are certified to be in compliance with IEC 60825 as a class 1 laser product. Consult the label on each part for laser certification numbers and approval information.

CAUTION:

This product might contain one or more of the following devices: CD-ROM drive, DVD-ROM drive, DVD-RAM drive, or laser module, which are Class 1 laser products. Note the following information:

- Do not remove the covers. Removing the covers of the laser product could result in exposure to hazardous laser radiation. There are no serviceable parts inside the device.
- Use of the controls or adjustments or performance of procedures other than those specified herein might result in hazardous radiation exposure.

(C026)

CAUTION:

Data processing environments can contain equipment transmitting on system links with laser modules that operate at greater than Class 1 power levels. For this reason, never look into the end of an optical fiber cable or open receptacle. (C027)

CAUTION:

This product contains a Class 1M laser. Do not view directly with optical instruments. (C028)

CAUTION:

Some laser products contain an embedded Class 3A or Class 3B laser diode. Note the following information: laser radiation when open. Do not stare into the beam, do not view directly with optical instruments, and avoid direct exposure to the beam. (C030)

CAUTION:

The battery contains lithium. To avoid possible explosion, do not burn or charge the battery.

Do Not:

- ___ Throw or immerse into water
- ___ Heat to more than 100°C (212°F)
- ___ Repair or disassemble

Exchange only with the IBM-approved part. Recycle or discard the battery as instructed by local regulations. In the United States, IBM has a process for the collection of this battery. For information, call 1-800-426-4333. Have the IBM part number for the battery unit available when you call. (C003)

Power and cabling information for NEBS (Network Equipment-Building System) GR-1089-CORE

The following comments apply to the IBM servers that have been designated as conforming to NEBS (Network Equipment-Building System) GR-1089-CORE:

The equipment is suitable for installation in the following:

- Network telecommunications facilities
- Locations where the NEC (National Electrical Code) applies

The intrabuilding ports of this equipment are suitable for connection to intrabuilding or unexposed wiring or cabling only. The intrabuilding ports of this equipment *must not* be metallically connected to the interfaces that connect to the OSP (outside plant) or its wiring. These interfaces are designed for use as intrabuilding interfaces only (Type 2 or Type 4 ports as described in GR-1089-CORE) and require isolation from the exposed OSP cabling. The addition of primary protectors is not sufficient protection to connect these interfaces metallically to OSP wiring.

Note: All Ethernet cables must be shielded and grounded at both ends.

The ac-powered system does not require the use of an external surge protection device (SPD).

The dc-powered system employs an isolated DC return (DC-I) design. The DC battery return terminal *shall not* be connected to the chassis or frame ground.

SAS subsystem for the 8202-E4B or 8205-E6B

Review the SAS subsystem features, configurations, and limitations for the 8202-E4B or 8205-E6B system.

SAS architecture

Serial-attached SCSI (SAS) architecture describes a serial device interconnection and transportation protocol that defines the rules for information exchange between devices.

SAS is an evolution of the parallel SCSI device interface into a serial point-to-point interface. SAS physical links are a set of four wires used as two differential signal pairs. One differential signal transmits in one direction, while the other differential signal transmits in the opposite direction. Data can be transmitted in both directions simultaneously. Physical links are contained in SAS ports, which contain one or more physical links. A port is a wide port if there are more than one physical link in the port. If there is only one physical link in the port, it is a narrow port. A port is identified by a unique SAS worldwide name (also called SAS address).

A *SAS adapter* contains one or more SAS ports. A *path* is a logical point-to-point link between a SAS initiator port in the adapter and a SAS target port in the I/O device (for example, a disk). A *connection* is a temporary association between an adapter and an I/O device through a path. A connection enables communication to a device. The adapter can communicate to the I/O device over this connection by using either the SCSI command set or the Advanced Technology Attachment (ATA) and Advanced technology Attachment Packet Interface (ATAPI) command set depending on the device type.

A *SAS expander* enables connections between an adapter port and multiple I/O device ports by routing connections between the expander ports. Only a single connection through an expander can exist at any given time. Using expanders creates more nodes in the path from the adapter to the I/O device. If an I/O device supports multiple ports, more than one path to the device can exist when there are expander devices included in the path.

A *SAS fabric* refers to the summation of all paths between all SAS adapter ports and all I/O device ports in the SAS subsystem including cables, enclosures, and expanders.

8202-E4B or 8205-E6B SAS subsystem overview

Review the SAS subsystem features and locations for the 8202-E4B or 8205-E6B system.

Use this information with your specific system unit and operating system documentation. General information is intended for all users of this product. Service information is intended for a service representative specifically trained on the system unit and subsystem being serviced.

Note: All SAS subsystem features for 8202-E4B or 8205-E6B systems share the same integrated base system board (CCIN 2BFB/2BFC), physical location code Un-P1.

Feature locations

Review the supported SAS features and their system locations. For detailed configuration information, see "SAS storage configurations" on page 5.

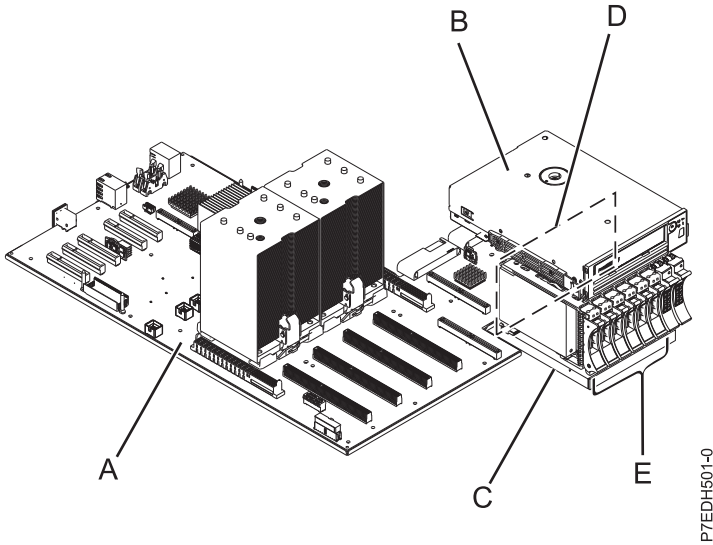


Figure 1. SAS base subsystem overview

Note: To order parts for your SAS subsystem, access the applicable FRU part number at 8202-E4B or 8205-E6B system parts.

Table 1. SAS base subsystem (Feature code 5618) components

Diagram location	Part name	CCINs	Physical location codes
A	Base backplane ¹	2BFB, 2BFC	Un-P1
B	Tape drive (optional) ¹	NA	Un-P1-D1 (SAS connector) or Un-P1-D2 (USB connector) Note: The tape drive bay is the same for both.
C	DVD drive ¹	NA	Un-P2-D9
D	Disk drive backplane	2BD5	Un-P2
E	Disk drives (6 SFF drive disk bays, 2 closed "filler" bays)	NA	Un-P2-D1 through Un-P2-D6

¹ Part of the SAS subsystem but separate from feature code 5618.

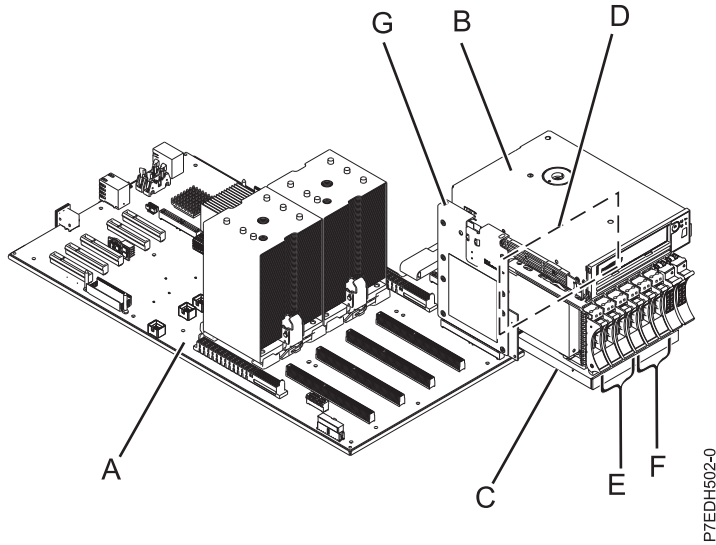


Figure 2. SAS two-way split drive backplane overview

Note: To order parts for your SAS subsystem, access the applicable FRU part number at 8202-E4B or 8205-E6B system parts.

Table 2. SAS base subsystem with two-way split drive backplane components (Feature Code 5631)

Diagram location	Part name	CCINs	Physical location codes
A	Base backplane ¹	2BFB, 2BFC	Un-P1
B	Tape drive (optional) ¹	NA	Un-P1-D1 (SAS connector) or Un-P1-D2 (USB connector) Note: The tape drive bay is the same for both.
C	DVD drive ¹	NA	Un-P2-D9
D	Disk drive backplane	2BD5	Un-P2
E	Disk drives (JBOD, RAID-0, or RAID-10)	NA	Un-P2-D1 through Un-P2-D3
F	Disk drives (JBOD or RAID-0)	NA	Un-P2-D4 through Un-P2-D6 (Un-P2-D7 and Un-P2-D8 are closed "filler" bays)
G	RAID-10 storage controller	2BE0 (feature code 5631)	Un-P1-C19

¹ Part of the SAS subsystem but separate from feature code 5631.

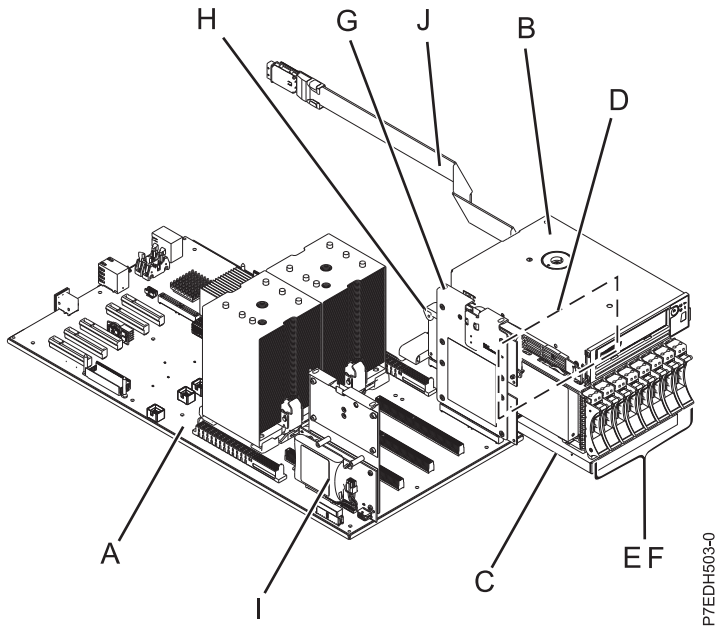


Figure 3. SAS dual-RAID subsystem overview

Note: To order parts for your SAS subsystem, access the applicable FRU part number at 8202-E4B or 8205-E6B system parts.

Table 3. SAS dual-RAID subsystem components (Feature code 5630)

Diagram location	Part name	CCINs	Physical location codes
A	Base backplane ¹	2BFB, 2BFC	Un-P1
B	Tape drive (optional) ¹	NA	Un-P1-D1 (SAS connector) or Un-P1-D2 (USB connector) Note: The tape drive bay is the same for both.
C	DVD drive ¹	NA	Un-P2-D9
D	8-disk-drive dual storage IOA backplane with removable media	2BD6	Un-P2
E, F	8 SFF disk drives	NA	Un-P2-D1 through Un-P2-D8
G	RAID/Cache storage controller	2BD9	Un-P1-C19
H	RAID enablement card	2BE1	Un-P1-C13
I	Cache battery card	2BCF	Un-P1-C14
J	SAS I/O attachment cable		Un-P2-T1
(not pictured)	Optional external SAS cables for storage on integrated RAID ¹ <ul style="list-style-type: none"> • 1.5 m – FC 3686 • 3.0 m – FC 3687 		

¹ Part of the SAS subsystem but separate from feature code 5630.

Feature details

SAS RAID adapters

The SAS RAID adapters have the following features:

- A host PCI-x at 66 MHz.
- Physical link (phy) speed of 3 Gbps SAS supporting transfer rates of 300 MB per second
- Optimized for SAS disk configurations that use dual paths through dual expanders for redundancy and reliability
- Adapter managed path redundancy and path switching for multiported SAS devices
- Embedded PowerPC® RISC Processor, hardware XOR DMA Engine, and hardware Finite Field Multiplier (FFM) DMA Engine (for Redundant Array of Independent Disks (RAID) 6)
- Support for RAID 0 and 10 disk arrays
- RAID disk arrays are supported as a boot device
- Advanced RAID features:
 - Hot spares for RAID 10 disk arrays
 - Background parity checking
 - Background data scrubbing
 - Disks formatted to 528 bytes per sector, providing cyclical redundancy checking (CRC) and logically bad block checking
 - Optimized skip read/write disk support for transaction workloads

Related information:

 [Serial attached SCSI cable planning](#)

SAS storage configurations

There are three supported SAS subsystem configurations on the 8202-E4B or 8205-E6B system.

The configuration you use depends on the combination of SAS features that you have installed on your system. The following table provides an overview of the features and related configurations.

Note: All SAS subsystem configurations for 8202-E4B or 8205-E6B systems share the same integrated base system board (CCIN 2BFB/2BFC), physical location code Un-P1.

Table 4. SAS subsystem configurations for the 8202-E4B or 8205-E6B system

SAS subsystem configuration	RAID Cache enablement card	External SAS components	SAS port cables	SAS cables	Limitations
SAS base subsystem (FC 5618)	No	None	None	Not applicable	Either solid-state drives (SSD) or hard disk drives (HDD) can be used, but the two can never be mixed in the same RAID array.

Table 4. SAS subsystem configurations for the 8202-E4B or 8205-E6B system (continued)

SAS subsystem configuration	RAID Cache enablement card	External SAS components	SAS port cables	SAS cables	Limitations
SAS base subsystem with two-way split drive backplane (FC 5631)	No	None	None	Not applicable	<ul style="list-style-type: none"> • IBM i is not supported. • Connecting to an external disk enclosure is not supported. • Each set of three drives can be HDDs or SSDs.
SAS dual-RAID subsystem configuration using internal disk drives and external disk enclosure (FC 5630)	Yes Note: The internal dual RAID IOA adapters report as CCIN 2BE1 and CCIN 2BD9.	External SAS port	SAS cable assembly for connecting to an external SAS drive enclosure	<ul style="list-style-type: none"> • YI cable (FC 3686) - System to SAS disk enclosure, Single adapter/Dual path 1.5 meter • YI cable (FC 3687) - System to SAS disk enclosure, Single adapter/Dual path 3 meter 	Both solid-state drives (SSD) and hard disk drives (HDD) can be used in the internal disk enclosure, but can never be mixed in the same RAID array. SSDs and HDDs cannot be mixed in the external disk enclosure. If an external SAS drawer is attached, only HDDs are supported.

Related concepts:

“8202-E4B or 8205-E6B SAS subsystem service considerations” on page 13

There are several considerations to review before servicing features within the SAS subsystem for the 8202-E4B or 8205-E6B system.

“Service considerations for the cache battery pack” on page 13

To prevent data loss, follow proper procedures before replacing the cache battery pack on the Cache RAID cards.

Related information:

 Serial attached SCSI cable planning

8202-E4B or 8205-E6B SAS subsystem base configuration

This configuration uses the base backplane.

The following rules apply to this configuration:

- The base backplane uses six drives and cannot function in dual-storage I/O-adapter (IOA) mode or in high-availability (HA) RAID mode.
- There is a single path to drives.
- Internal adapter slots must be empty (slots Un-P1-C13, Un-P1-C14, and Un-P1-C19).
- Because there is no NVRAM, drives are JBOD and RAID-0 only.
- Solid-state drives (SSD) and hard disk drives (HDD) can be mixed in any combination within the internal disk enclosure.

Example: Base backplane

This example shows a base backplane configuration on the 8202-E4B or 8205-E6B system.

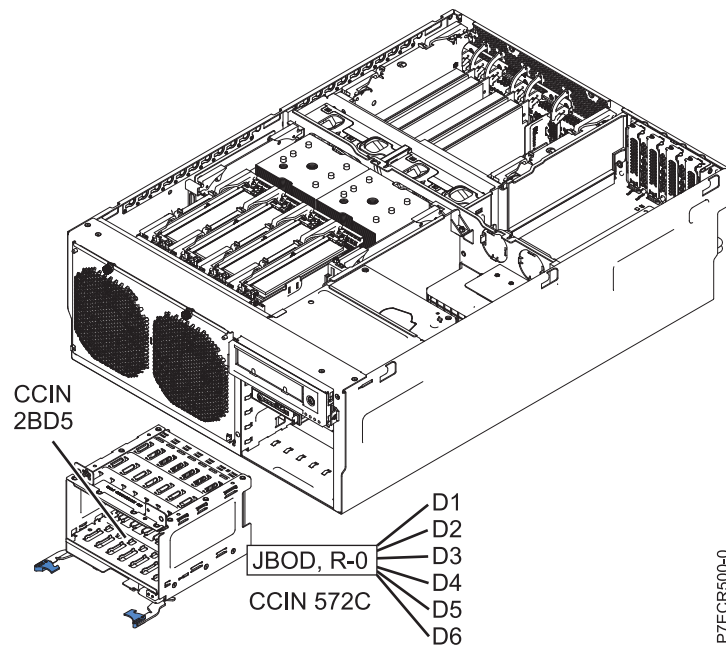


Figure 4. Disk bays controlled by base backplane

The following table lists the details of the base backplane configuration on the 8202-E4B or 8205-E6B system.

Table 5. Configuration details

Embedded SAS	Configuration details
JBOD storage controller (on base system board)	<ul style="list-style-type: none"> The base backplane is located at Un-P1. The controller reports as CCIN 572C. Six JBOD drives (Un-P2-D1 through Un-P2-D6, 2 closed "filler" bays) are included on base disk drive backplane. There is a single path to each drive. RAID-0 storage is supported.

8202-E4B or 8205-E6B SAS base subsystem with two-way split drive backplane

This configuration uses a two-way split backplane.

The following rules apply to this configuration:

- Each SAS adapter can only detect three of the disk drives and cannot function in dual-storage I/O adapter (IOA) mode or in high availability (HA) RAID mode. One SAS adapter (RAID-10 storage controller) connects to D1, D2, and D3. The other SAS adapter (JBOD storage controller) connects to D4, D5, and D6.
- The SAS adapters can be assigned to separate partitions for boot devices.
- This configuration supports disks without RAID (referred to as JBOD) or RAID drives. However, RAID drives are limited to three drives and no write cache.

- RAID 10 with two drives is limited. A RAID 10 array with two drives is equivalent to RAID 1 (mirrored drives). A RAID 0 disk array with one drive is similar to JBOD support. A RAID 10 array with 1 or 3 drives is not allowed.
- Solid-state drives (SSD) and hard disk drives (HDD) can be used, but can never be mixed in the same disk enclosure.
- SSD and HDD can both be present in a split backplane if each side of the split backplane has only SSD or HDD. The supported configurations are as follows:
 - SSD on D1 through D3, and HDD on D4 through D6
 - HDD on D1 through D3, and SSD on D4 through D6
 - SSD on D1 through D6
 - HDD on D1 through D6

Example: Two-way split drive backplane

This example shows a two-way split drive backplane configuration on the 8202-E4B or 8205-E6B system. The embedded SAS adapter controls three disk drives and the backplane storage controller controls three drives in addition to DVD and optional tape storage.

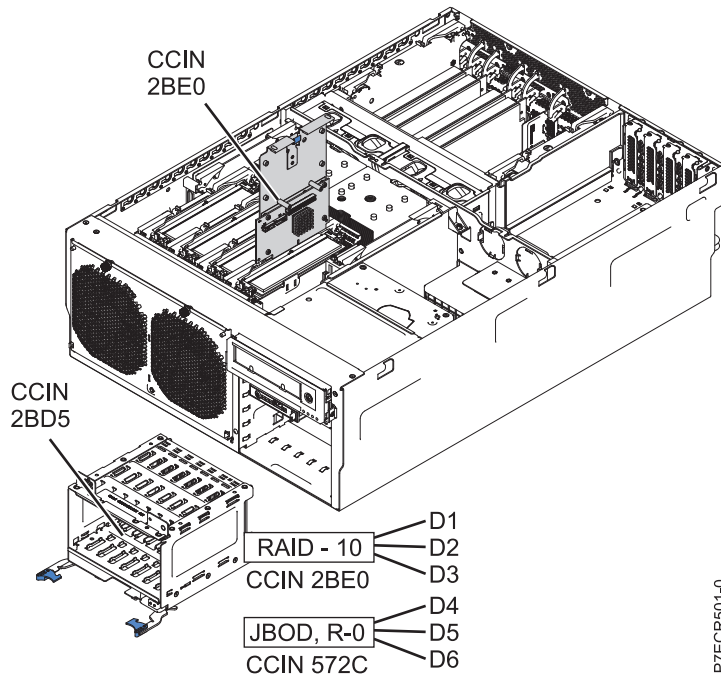


Figure 5. Embedded SAS adapter in a two-way split drive backplane

The following table lists the details of the two-way split drive backplane configuration on the 8202-E4B or 8205-E6B system.

Table 6. Configuration details

Embedded SAS	Configuration details
RAID-10 storage controller	<ul style="list-style-type: none"> • Features are located at Un-P1-C19. • The configuration controls D1, D2, and D3. • A single path goes to each drive. • JBOD, RAID 0, and RAID 10 are supported. • Physical connections to the SAS cable are disabled. If the external SAS port is installed, it is not functional. • The SAS adapter reports as CCIN 2BE0.
JBOD storage controller (base backplane)	<ul style="list-style-type: none"> • Features are located at Un-P1. • The configuration controls D4, D5, and D6. • A single path goes to each drive. • JBOD and RAID 0 are supported. • Physical connections to the SAS cable are disabled. If the external SAS port is installed, it is not functional. • The controller reports as CCIN 572C.

8202-E4B or 8205-E6B SAS dual-RAID subsystem

The dual-RAID subsystem configuration can be used with both internal and external disk drives or with only internal disk drives.

8202-E4B or 8205-E6B SAS dual-RAID subsystem with internal drives

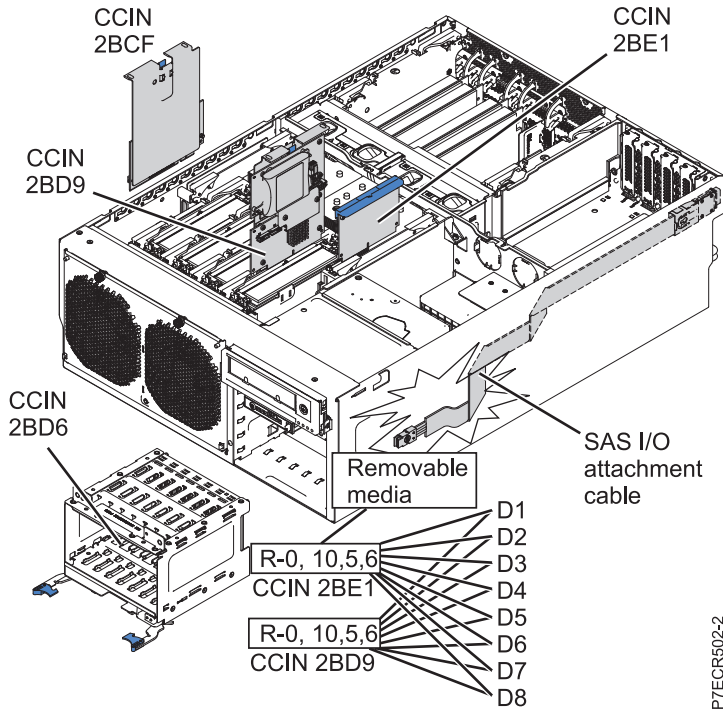
This configuration uses dual-storage I/O adapter (IOA) mode or high availability (HA) RAID mode with internal disk drives.

This configuration increases availability using dual-storage IOA or high availability (HA) to connect multiple adapters to a common set of internal disk drives. It also increases the performance of RAID arrays. The following rules apply to this configuration:

- This configuration uses dual Cache RAID enablement cards.
- Using the RAID enablement cards with port expanders, the two embedded adapters can connect to each other and all eight disk drives.
- The disk drives are required to be in RAID arrays.
- There are no separate SAS cables required to connect the two embedded SAS RAID adapters to each other. The connection is contained within the backplane.
- RAID 0, 10, 5, and 6 support up to eight drives.
- Solid-state drives (SSD) and hard disk drives (HDD) can be used, but can never be mixed in the same RAID array. An SSD-only RAID set and an HDD-only RAID set is supported.
- SAS I/O attachment cable for optional connection to external storage.

Example: SAS dual-RAID subsystem with internal drives

This example provides an overview of the dual-storage I/O adapter (IOA) configuration using internal disk drives on the 8202-E4B or 8205-E6B system.



P7EGR502-2

Figure 6. Disk bays controlled by both embedded SAS adapters when using SAS dual-RAID subsystem with internal drives

The following table lists the configuration details.

Table 7. Configuration details

Embedded SAS	Configuration details
RAID enablement card	<ul style="list-style-type: none"> RAID enablement card (CCIN 2BE1) in tandem with separate cache battery card (CCIN 2BCF) creates a RAID adapter. The RAID controller card with cache battery card attached (CCIN 2BD9) provides another RAID adapter. The two SAS adapters connect to all eight disk drives. Physical connections to the SAS cable are enabled in order to attach to another SAS port expander in an external disk enclosure using a YI cable.
RAID/Cache storage controller	
Cache battery card	

Related concepts:

“8202-E4B or 8205-E6B SAS subsystem service considerations” on page 13

There are several considerations to review before servicing features within the SAS subsystem for the 8202-E4B or 8205-E6B system.

“Service considerations for the cache battery pack” on page 13

To prevent data loss, follow proper procedures before replacing the cache battery pack on the Cache RAID cards.

8202-E4B or 8205-E6B SAS dual-RAID subsystem with external drives

This configuration uses dual-storage I/O adapter (IOA) mode or high availability (HA) RAID mode with internal and external disk drives.

You can increase availability using high availability to connect multiple adapters to a common set of internal disk drives and external disk enclosures. The following rules apply to this configuration:

- This configuration uses dual cache RAID enablement cards.

- Using the RAID enablement cards with port expanders, the two embedded adapters can connect to each other and all eight disk drives.
- The disk drives are required to be in RAID arrays.
- There are no separate SAS cables required to connect the two embedded SAS RAID adapters to each other. The connection is contained within the backplane.
- RAID 0, 10, 5, and 6 support up to eight drives.
- Solid-state drives (SSD) and hard disk drives (HDD) can be used, but can never be mixed in the same RAID array. An SSD-only RAID set and an HDD-only RAID set is supported.
- The external SAS port is used for expansion to external SAS devices or drawers.
- The external SAS port cannot connect to a SAS drawer that is populated with SSDs.
- The external SAS port cannot connect to a SAS drawer at all (even if it is populated with HDDs) if any SSDs are used in the RAID configuration.

Example: SAS dual-RAID subsystem with external drives

This example provides an overview of the SAS dual-RAID subsystem configuration using external disk drives on the 8202-E4B or 8205-E6B system.

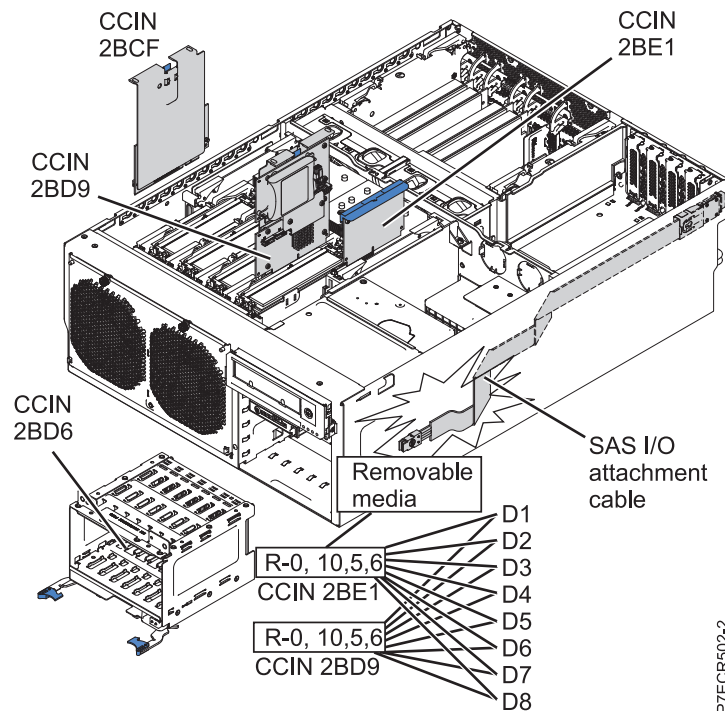


Figure 7. Disk bays controlled by both embedded SAS adapters when using SAS dual-RAID subsystem with external drives

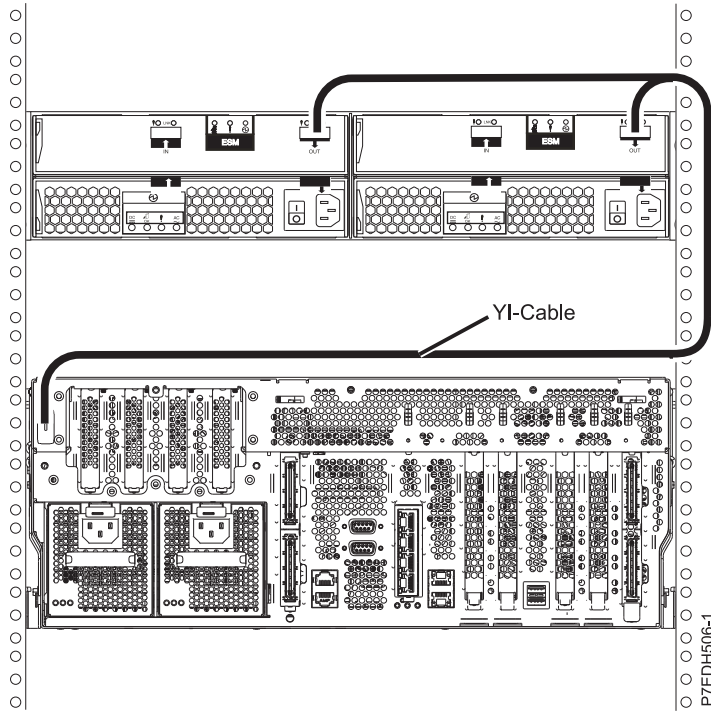


Figure 8. Physical connection to attach external disk enclosures

The following table lists the configuration details.

Table 8. Configuration details

Embedded SAS	Configuration details
RAID enablement card (Un-P1-C13)	<ul style="list-style-type: none"> • RAID enablement card (CCIN 2BE1) in tandem with separate cache battery card (CCIN 2BCF) creates a RAID adapter. • RAID controller card with cache battery card attached (CCIN 2BD9) provides another RAID adapter. • The SAS adapters connect to all eight disk drives and any drives attached by the external cable. • Physical connections to the SAS cable are enabled in order to attach to another SAS port expander in an external disk enclosure using a YI cable.
RAID/Cache storage controller (Un-P1-C19)	
Cache battery card (Un-P1-C14)	
8-bay disk drive backplane (Un-P2)	

Related concepts:

“8202-E4B or 8205-E6B SAS subsystem service considerations” on page 13

There are several considerations to review before servicing features within the SAS subsystem for the 8202-E4B or 8205-E6B system.

“Service considerations for the cache battery pack” on page 13

To prevent data loss, follow proper procedures before replacing the cache battery pack on the Cache RAID cards.

8202-E4B or 8205-E6B SAS subsystem service considerations

There are several considerations to review before servicing features within the SAS subsystem for the 8202-E4B or 8205-E6B system.

Attention: Do not attempt to remove any parts related to the SAS subsystem if the cache data present LED on the card in either P1-C19 or P1-C14 is flashing. To see this LED, you must shut down the system and remove the service cover. The LED shows a no-touch icon (a hand with a slash through it), and indicates that there is possible data in cache on the adapter. To prevent data loss, first make sure that the system has been shut down correctly. If either cache data present LED is flashing, refer to one of the following topics before removing any SAS subsystem parts. You can safely replace the cache battery pack when Yes is displayed next to Battery pack can be safely replaced on the Battery Information panel (for Linux and IBM i systems) or COMMAND STATUS panel (for AIX® systems).

Before servicing any features, review the I/O configurations for each logical partition on your system. It is important to understand the differences between the various configurations and the resulting service considerations. In addition, consider possible impacts to the following areas.


- Logical partitions and their I/O adapter assignments
- RAID array configurations
- Physical disk locations
- Path to your boot device

Related information:

 [Displaying rechargeable battery information](#)

 [Displaying rechargeable battery information](#)

 [Displaying rechargeable battery information](#)

 [Logical partitioning](#)

 [SAS RAID controllers for IBM i](#)

 [SAS RAID controllers for Linux](#)

 [SAS RAID controllers for AIX](#)

Service considerations for the cache battery pack

To prevent data loss, follow proper procedures before replacing the cache battery pack on the Cache RAID cards.

Note: Concurrent maintenance of adapter battery is not supported. Even with failed or missing batteries, the card associated with the battery must first be removed. For more information, see Removing and replacing SAS RAID adapters and batteries.

Attention: To maintain system availability and prevent possible data loss, you must understand that these features have implications on the SAS configuration and data accessibility of the system.

Attention: Do not attempt to remove any parts related to the SAS subsystem if the cache data present LED on the card in either P1-C19 or P1-C14 is flashing. To see this LED, you must shut down the system and remove the service cover. The LED shows a no-touch icon (a hand with a slash through it), and indicates that there is possible data in cache on the adapter. To prevent data loss, first make sure the system has been shut down correctly. If either cache data present LED is flashing, refer to one of the following topics before removing any SAS subsystem parts. You can safely replace the cache battery pack when Yes is displayed next to Battery pack can be safely replaced on the Battery Information panel (for the Linux and IBM i systems) or COMMAND STATUS panel (for AIX systems).

The following figure shows the location of the cache data present LED in the 8202-E4B or 8205-E6B SAS subsystem.

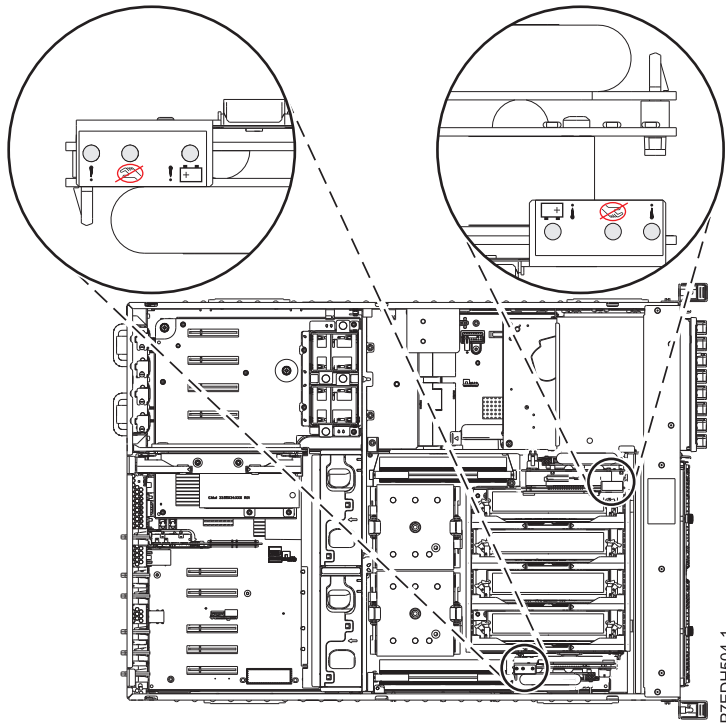










Figure 9. Cache data present LED

The following table describes the states of the cache data present LED and what to consider before attempting a service action.

Table 9. LED indications and actions

Cache battery card (Un-P1-C14)	RAID/Cache storage controller (Un-P1-C19)	Indication	Action
 Off	 Off	Cache is not active.	Service actions can proceed.
 Off	 Flashing	Cache is active on C19. Cache might have been flushed on C14 if C19 is failed.	Attempt to power on and perform a proper shutdown prior to any service action.
 Flashing	 Off	Cache is active on C14. Cache might have been flushed on C19 if C14 is failed.	Attempt to power on and perform a proper shutdown prior to any service action.
 Flashing	 Flashing	Cache is active on the dual controllers.	Attempt to power on and perform a proper shutdown prior to any service action. If this is unsuccessful in clearing the cache active LEDs, contact support. See Contacting IBM service and support.

Related information:

- [🔗 Displaying rechargeable battery information](#)
- [🔗 Displaying rechargeable battery information](#)
- [🔗 Displaying rechargeable battery information](#)
- [🔗 Removing and Replacing a cache battery pack](#)

Problem determination and recovery

Review the following information about using problem determination and recovery procedures for the 8202-E4B or 8205-E6B system.

Attention: To maintain system availability and prevent possible data loss, contact your next level of support for any service related to the SAS storage subsystem on the 8202-E4B or 8205-E6B system.

For more details on service, support, service request numbers (SRNs), and feature information for the SAS storage subsystem, refer to the following information:

- Planning for cables
- Removing and replacing SAS RAID adapters and batteries
- Installing the external SAS port on a 8202-E4B or 8205-E6B
- Service request numbers

Related information:

- [🔗 SAS RAID controllers for AIX](#)
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Technical Regulations, Department M372
IBM-Allee 1, 71139 Ehningen, Germany
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